

## Foreword

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Today, the Journal Editorial Board is composed of thirteen associate editors from six different countries. These individuals are experts in many areas and help ensure the quality and relevance of the content that we publish. Without these dedicated people the Journal would not be possible. Therefore, it is my pleasure to recognize our newest editorial board member, Dr. Jens Müller.

Dr. Müller studied electrical engineering at Technical University of Ilmenau (Ilmenau, Germany) where he received his Ph.D. in 1997. His dissertation work focused on integration of RF passive components in LTCC. In 1997 he joined the substrate engineering group at Micro Systems Engineering GmbH (MSE), Berg/Germany. From 1998 to 2005, he served as the head of the electronics development group at MSE and was responsible for a range of projects including the medical in-house

business, OEM business, and a variety of collaborative projects (substrate and assembly technologies). Since June of 2005 he has led the Research Group Functionalised Peripherics (Macro-Nano® Centre for Innovation Competence) at the Technical University of Ilmenau. His main research focus includes ceramic packaging and interconnects for microwave, as well as biosensing and chemical systems. Dr. Müller has also written several book chapters and served as the Vice President of IMAPS Germany, and the President of IMAPS Germany.

His extensive experience and dedication to IMAPS will be a great asset for the Journal, and it is a great honor and privilege to be able to work with him on this publication.

Fred D. Barlow III, Ph.D.  
Editor-in-Chief